Appl. No. 10/422,200

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PINK LIGHT EMITTING DIODE BACKGROUND OF THE INVENTION

Field of the invention

The present invention relates to a pink light emitting diode used in LED display, back light, traffic signal, indicator, etc. and in particular, to a pink light emitting diode comprises a blue LED chip and mixed fluorescent powder material which includes a red fluorescent powder and yellow fluorescent powder.

DESCRIPTION OF THE RELATED ART

The light emitting diode (LED) has the advantages of being electricity-saving, high reliability, recyclable, and safety. Thus, it has been used widely in various applications, such as an indicators and light sources. Recently light emitting diode for RGB (red, green, and blue) colors having ultra-high luminance and high efficiency have been developed. Large screen LED displays using these light emitting diode have been put into use. The LED display can be operated with less power and has such good characteristics as light weight and long life, and is therefore expected to be more widely use in the future.

Please refer to FIG. 1, it is a traditional LED lamp includes a blue LED chip 1, a lead frame 3, wires 4, a yellow fluorescent powder 8, and a compound layer 5.

The LED chip 1 is mounted on the lead frame 3. The wires 4 are electrically connected the LED chip 1 to the lead frame 3. The yellow fluorescent powder 8 is coated on the LED chip 1. The compound layer 5 is encapsulated on the LED chip1 to finish the package of the LED.

A method of manufacturing LED is to use various semiconductor materials to emit light of different wavelength. A traditional method of manufacturing mixed light used at least two chips to emit light of different wavelength, so as to mix various light of different wavelength may produce mixed light as white light.

Further a traditional method of manufacturing mixed light of light emitting diode is to provide a fluorescent powder coated on the surface of the LED chip. The fluorescent powder is capable of absorbing a part of light emitted by LED chip (eg. blue light) and emits light of a different wavelength from that of the

absorbed light to produce another find of color light. Mix the light emitted and the absorbed may produce a mixed light. (eg. white light)

At present time, a mixed light is used to produce white light, which provides a yellow fluorescent powder coated on the surface of a blue light LED chip to emit yellow light. Mixing the yellow light and the blue light may produce white light, for example, the US 5998925 patent of a white light emitting diode of Nichia Corporation.

Furthermore, a method of manufacturing mixed light is to mix a red fluorescent powder, blue fluorescent powder, and green fluorescent coated on a purple LED chip with a wavelength in the range of 360nm-390nm to produce white light or various kinds of color light, for example, the US 5952684 patent of Solidlite Corporation.

The method of manufacturing mixed light of Nichia Corporation as above mentioned does not produce pink light emitting diode.

SUMMARY OF THE INVENTION

The objective of the present invention is to provide a pink white light emitting diode. It is manufactured conveniently, therefore, the manufacturing processes are simplified and the manufacturing cost must be decreased.

The further objective of the present invention is to provide a pink light emitting diode with a high luminance for a long period time.

To achieve the above-mentioned objective, a pink light emitting diode of the present invention comprises a blue LED chip and mixed fluorescent powder material that includes a yellow fluorescent powder and a red fluorescent powder, wherein the yellow fluorescent powder which absorbs a part of blue light emitted by the blue LED chip and emits a yellow light, the red fluorescent powder which absorbs a part of blue light emitted by the blue LED chip and emits red light, to mix the blue light, yellow light, and red light may produce pink light emitting diode.

According to the aspect of the present invention, the pink light emitting diode has the advantage of high stability, lower cost, and high luminance for a

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long period of time.

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BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic illustration showing a traditional LED lamp.

FIG 2 is a schematic illustration showing a pink light emitting diode lamp of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

Please refer to FIG. 2. It is a schematic illustration showing a pink light diode lamp of the present invention includes a blue LED chip 10, a lead frame 20, wires 30, a mixed fluorescent powder material 40, and a compound layer 50.

The LED chip 10 that emits a wavelength in a range of 425 nm - 455nm, the LED chip 10 is mounted on the lead frame 20.

The wires 30 are electrically connected the bonding pads of the LED chip 10 to the lead frame 20 for transmitting signal from the blue LED chip 10 to the lead frame 20.

The mixed fluorescent powder material which includes a yellow fluorescent powder and a red fluorescent powder, is formed on the blue LED, wherein the yellow fluorescent powder which absorbs a part of blue light emitted by the blue LED chip 10 and emits a yellow light, the red fluorescent powder which absorbs a part of blue light emitted by the blue LED chip 10 and emits red light, to mix the blue light, yellow light, and red light may produce pink light emitting diode.

In the embodiment, the red fluorescent powder is formed of $Mg_6 As_2O_{11}$: Mn or $3.5MgO \cdot 0.5MgF_2$: Mn.

The red fluorescent powder is formed of Y_3 Al_5O_{12} : Ce or $(Y,Gd)_3Al_5$ O_{12} : Ce,S

The compound layer 50 is encapsulated on the blue LED chip 10, wires 30, and mixed fluorescent powder material 40.

Therefore, the pink light emitting diode of the present invention has the following advantages.

1. Since the red fluorescent powder and yellow fluorescent powder are formed of

Oxide, the pink light emitting diode of the present invention has high stability, lower cost, and high luminance for a long period of time.

2. Since the manufacturing processes can be simplified, and the manufacturing costs also can be lowered.

While the invention has been described by the way of an example and in terms of a preferred embodiment, it is to be understood that the invention is not limited to the disclosed embodiment. On the contrary, it is intended to cover various modifications. Therefore, the scope of the appended claims should be accorded the broadest interpretation so as to encompass all such modifications.

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